Electronic Supplementary Material (ESI) for RSC Advances

Electrochemical formation of Cu/Ag surfaces and their applicability as heterogeneous catalysts

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Supplementary Information

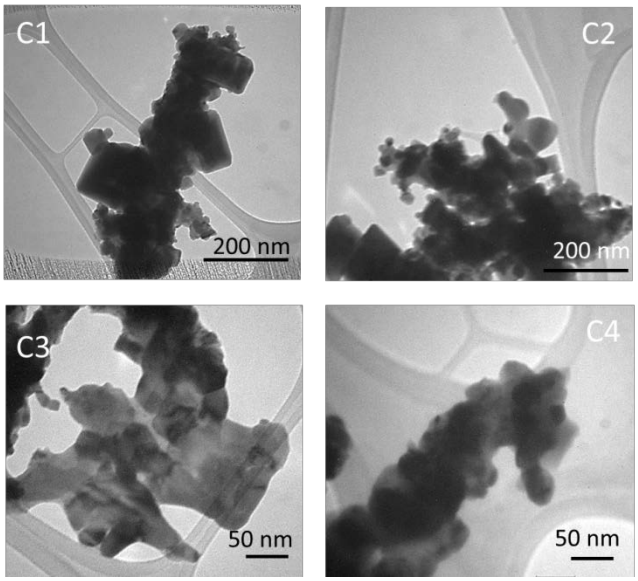

Figure S1: SEM images of porous Cu/Ag (C1-C4) electrodeposited at – 3 A cm^{-2} on copper foil from 0.4 M $CuSO_4$ in 1.5 M H_2SO_4 containing 5 mM (C1), 10 mM (C2), 20 mM (C3) and 50 mM (C4) $AgNO_3$ and then removed via sonication.